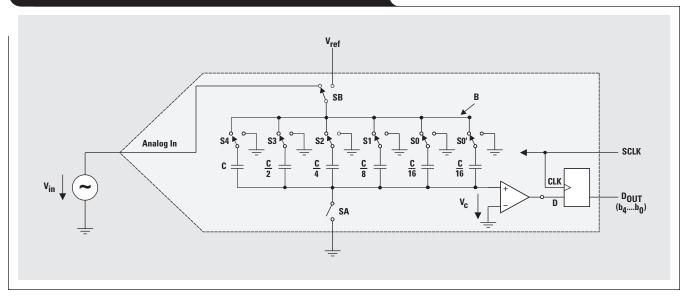
The operation of the SAR-ADC based on charge redistribution

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Figure 1. Five-bit SAR-ADC based on charge redistribution



All Texas Instruments TLV- and TLC-series sequential serial analog-to-digital converters perform successive approximation based on charge redistribution. This article explains the operation of the SAR (successive approximation register)-ADC (analog-to-digital converter). It provides a concise description of a model SAR-ADC based on charge redistribution. Figure 1 shows the simplified circuit of a 5-bit charge redistribution converter using switched capacitor architecture.

All capacitors have binary weighted values, i.e., C, C/2, $C/4,....C/2^{n-1}$. The last two capacitors having the value

C/2ⁿ⁻¹ are connected so that the total capacitance of the n+1 capacitors is 2C. MOS-transistors are used to implement the required n+3 switches, and the voltage comparator provides the appropriate steering of the switches via auxiliary logic circuitry. The conversion process is performed in three steps: the sample mode, the hold mode, and the redistribution mode (in which the actual conversion is performed).

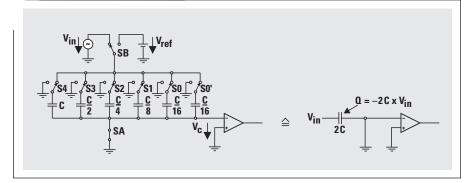
Sample mode

In the sampling mode (Figure 2), switch SA is closed and SB is switched to the input voltage V_{in} . The remaining switches are turned to the common bus B. Due to charging, a total charge of $Q_{in} = -2 \text{C x } V_{in}$ is stored on the lower plates of the capacitors.

Hold mode

During the hold mode (Figure 3), switch SA is opened while the switches S4....SO' are connected to ground,

Figure 2. Sample mode



thereby applying a voltage of $V_{c}=-V_{\rm in}$ to the comparator input. This means that the circuit already has a built-in sample-and-hold element.

Redistribution mode

The actual conversion is performed by the redistribution mode. The first conversion step, shown in Figure 4, connects C (the largest capacitor) via switch S4 to the reference voltage V_{ref}, which corresponds to the full-scale range (FSR) of the ADC.

Capacitor C forms a 1:1 capacitance divider with the remaining capacitors connected to ground. The comparator input voltage becomes $V_C = -V_{in} + V_{ref}/2$. If $V_{in} > V_{ref}/2$, then $V_C < 0$, and the comparator output goes high, providing the most significant bit MSB (bit 4) = 1. On the other hand, if $V_{in} < V_{ref}/2$, then $V_C > 0$, and bit 4 = 0.

The second conversion step connects C/2 to V_{ref} . If the first conversion step resulted in bit 4=1, switch S4 is turned to ground again to discharge C as shown in Figure 5; otherwise it remains connected to V_{ref} if bit 4=0 (Figure 6), resulting in a comparator input voltage $V_c = V_{in} + \text{bit } 4 - V_{ref}/2 + V_{ref}/4$.

According to this voltage, the next most significant bit (bit 3) is obtained by comparing V_{in} to 1/4 V_{ref} or 3/4 V_{ref} through the different voltage dividers. Switch S3 is then either turned to ground if bit 3 = 1, thereby discharging C/2, or S3 remains connected to V_{ref} if bit 3 = 0.

This process continues until all bits are generated, with the final conversion step being performed at a comparator input voltage of $V_C = -V_{in} + \text{bit } 4 \times V_{ref}/2 + \text{bit } 3 \times V_{ref}/4 + \text{bit } 2 \times V_{ref}/8 + \text{bit } 1 \times V_{ref}/16 + \text{bit } 0 \times V_{ref}/32.$

Related Web site

www.ti.com/sc/docs/products/msp/dataconv/index.htm

Figure 3. Hold mode

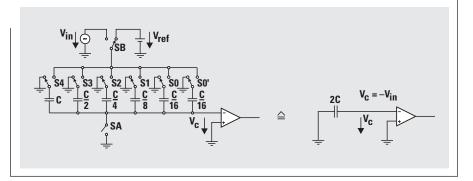


Figure 4. Conversion Step 1 determines the MSB (bit 4)

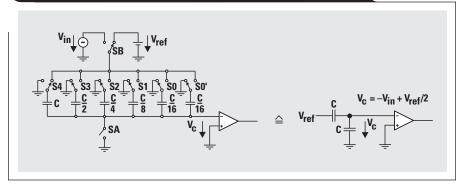


Figure 5. If bit 4 = 1, V_{in} is compared with 3/4 V_{ref}

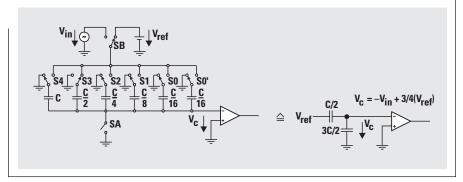
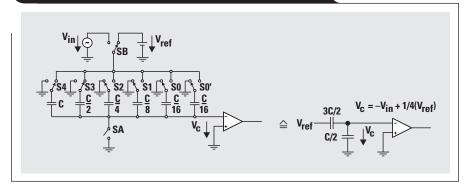


Figure 6. If bit 4 = 0, V_{in} is compared with 1/4 V_{ref}



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